

Features

- Trench MOSFET Technology
- Low Q_g
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

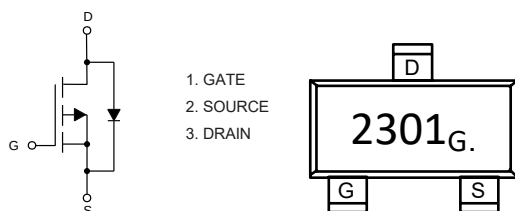
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 356°C/W Junction to Ambient (Note2)

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V _{DS}	-19	V
Gate-Source Voltlage		V _{GS}	±10	V
Continuous Drain Current	T _A =25°C	I _D	-1.5	A
	T _A =100°C		-0.95	
Pulsed Drain Current ^(Note3)		I _{DM}	-6	A
Total Power Dissipation ^(Note4)		P _D	0.35	W

Note:

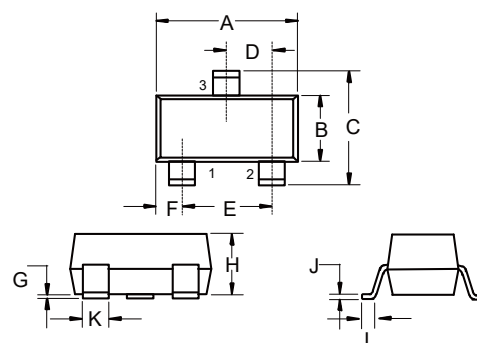
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-ambient thermal resistance.

Internal Structure and Marking Code



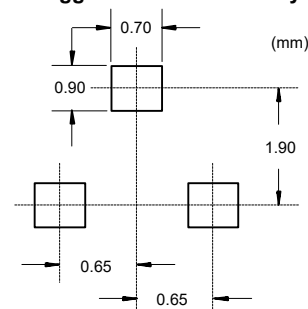
P-CHANNEL MOSFET

SOT-323



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.071	0.087	1.80	2.20	
B	0.045	0.053	1.15	1.35	
C	0.083	0.096	2.10	2.45	
D	0.026		0.65		TYP.
E	0.047	0.055	1.20	1.40	
F	0.012	0.016	0.30	0.40	
G	0.000	0.004	0.00	0.10	
H	0.035	0.044	0.90	1.10	
J	0.002	0.010	0.05	0.25	
K	0.006	0.016	0.15	0.40	
L	0.010	0.018	0.26	0.46	

Suggested Solder Pad Layout



Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-19			V
Gate-Source Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 10V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-19V, V_{GS}=0V$			-1	μA
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.4	-0.62	-1.0	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-1.5A$		80	108	m Ω
		$V_{GS}=-2.5V, I_D=-1.5A$		105	140	
		$V_{GS}=-1.8V, I_D=-1.5A$		150	230	
Gate Resistance	R_G	f=1 MHz, Open drain		16		Ω
Diode Characteristics						
Continuous Body Diode Current	I_S				-1.5	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=-1.5A$			-1.2	V
Reverse Recovery Time	t_{rr}	$I_F=-1.5A, dI_F/dt=100A/\mu s$		11		ns
Reverse Recovery Charge	Q_{rr}			5		nC
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS}=-10V, V_{GS}=0V, f=1MHz$		208		pF
Output Capacitance	C_{oss}			36		
Reverse Transfer Capacitance	C_{rss}			29		
Total Gate Charge	Q_g	$V_{DS}=-10V, V_{GS}=-4.5V, I_D=-1.5A$		2.9		nC
Gate-Source Charge	Q_{gs}			0.32		
Gate-Drain Charge	Q_{gd}			0.54		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=-10V, V_{GS}=-4.5V, R_G=2.5\Omega, I_D=-1A$		6.4		ns
Turn-On Rise Time	t_r			5.4		
Turn-Off Delay Time	$t_{d(off)}$			23		
Turn-Off Fall Time	t_f			16		

Curve Characteristics

Fig. 1 - Typical Output Characteristics

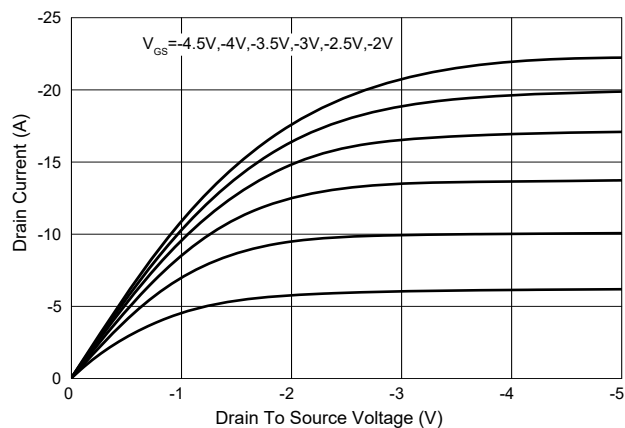


Fig. 2 - Transfer Characteristics

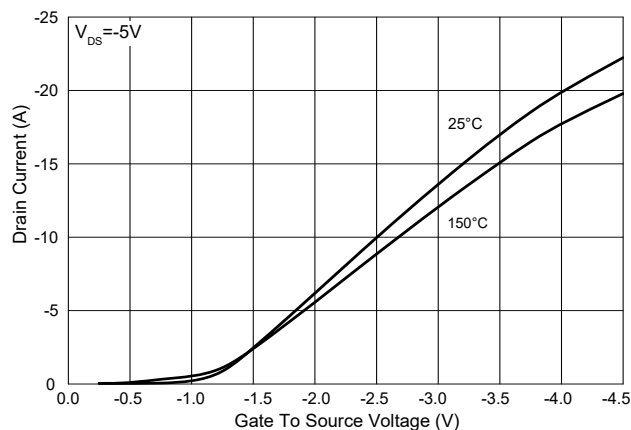


Fig.3 - $R_{DS(ON)}$ - V_{GS}

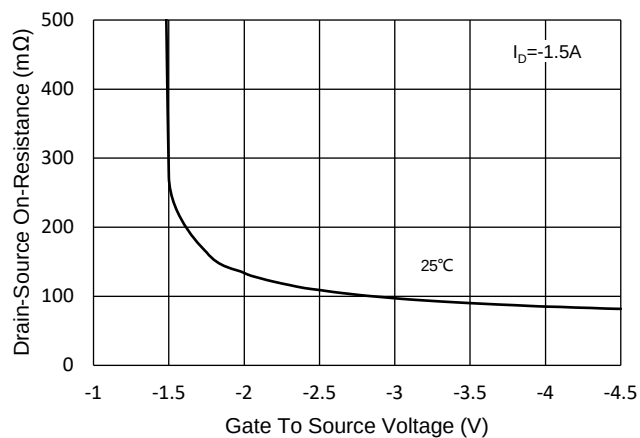


Fig.4 - $R_{DS(ON)}$ - I_D

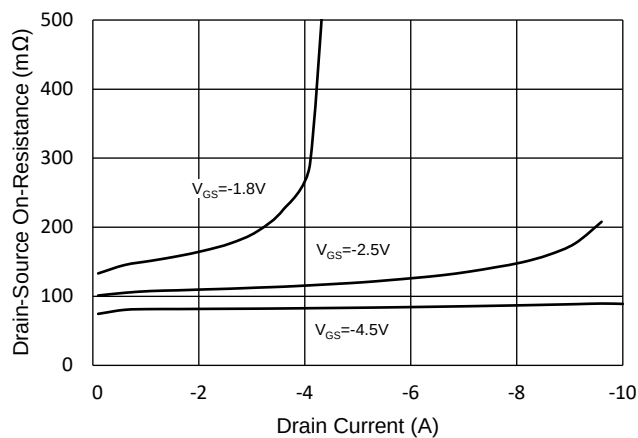


Fig. 5 - Capacitance Characteristics

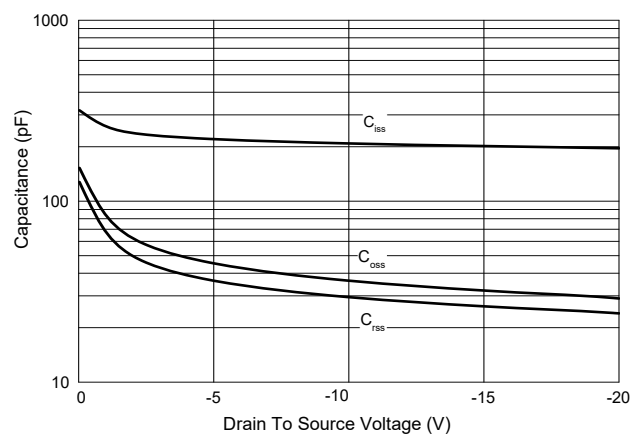
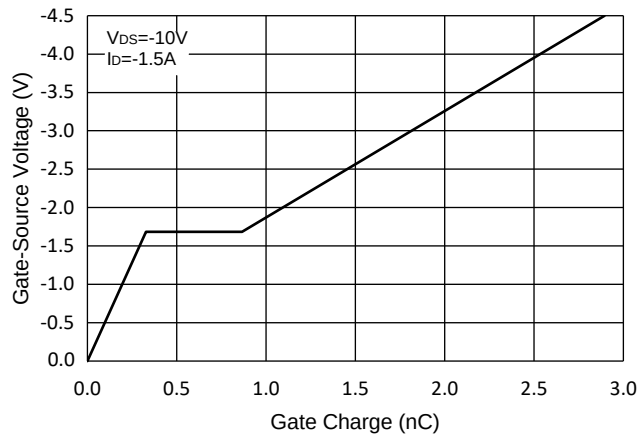


Fig.6 - Gate Charge



Curve Characteristics

Fig.7 - Normalized Threshold Voltage

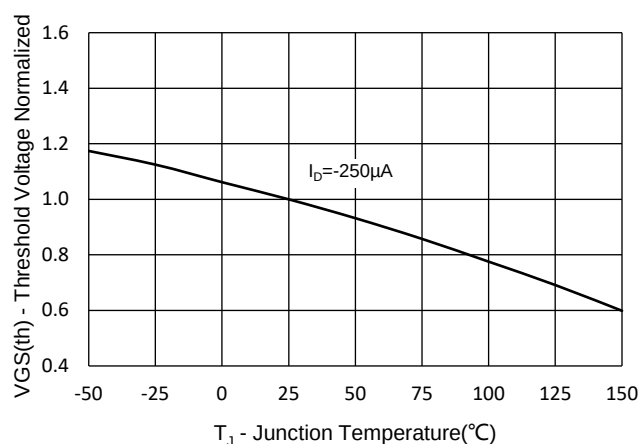


Fig.8 - Normalized On Resistance Characteristics

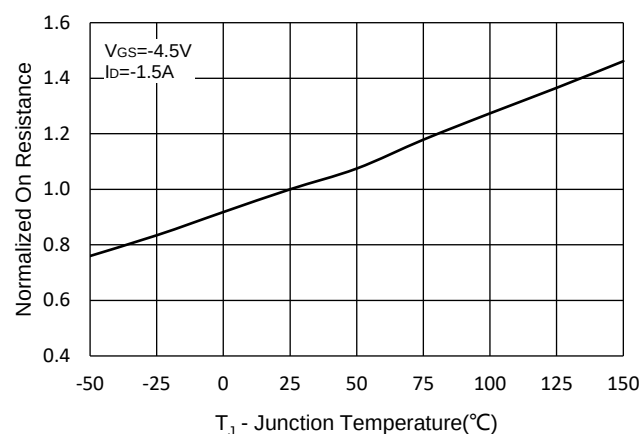


Fig.9 - $I_S - V_{SD}$

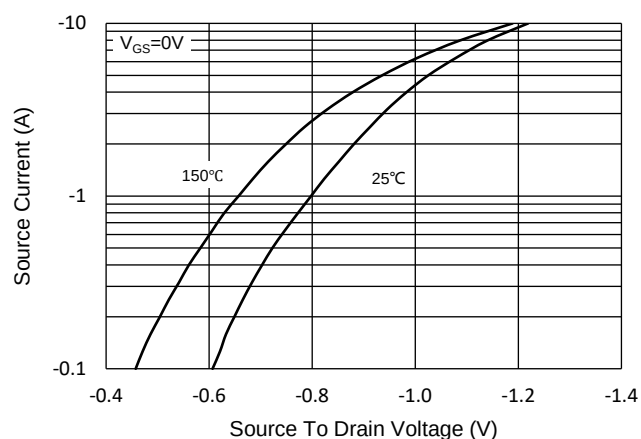


Fig.10 - Drain Current

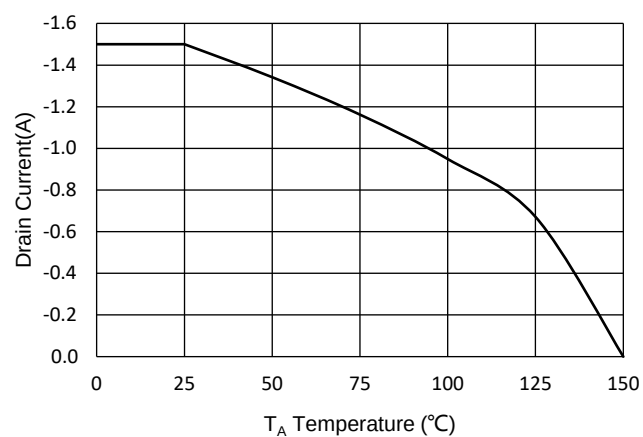
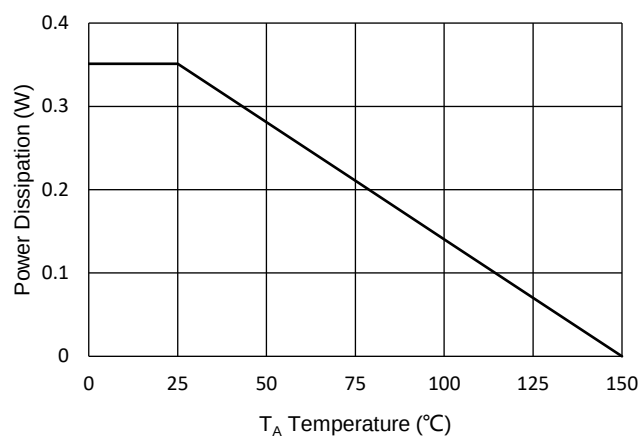


Fig.11 - PD Dissipation



Curve Characteristics

Fig.12 - Safe Operation Area

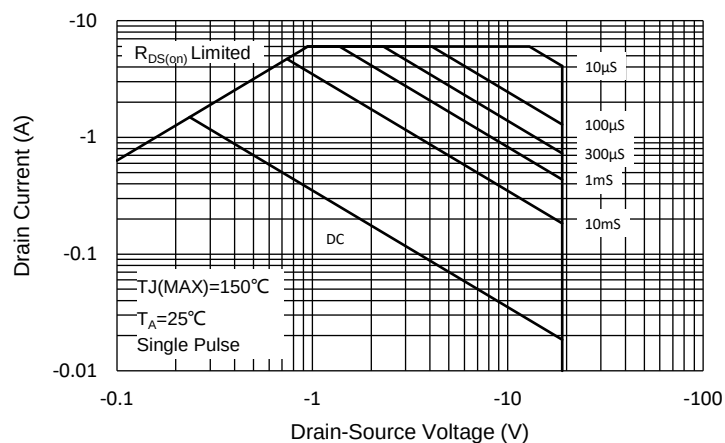
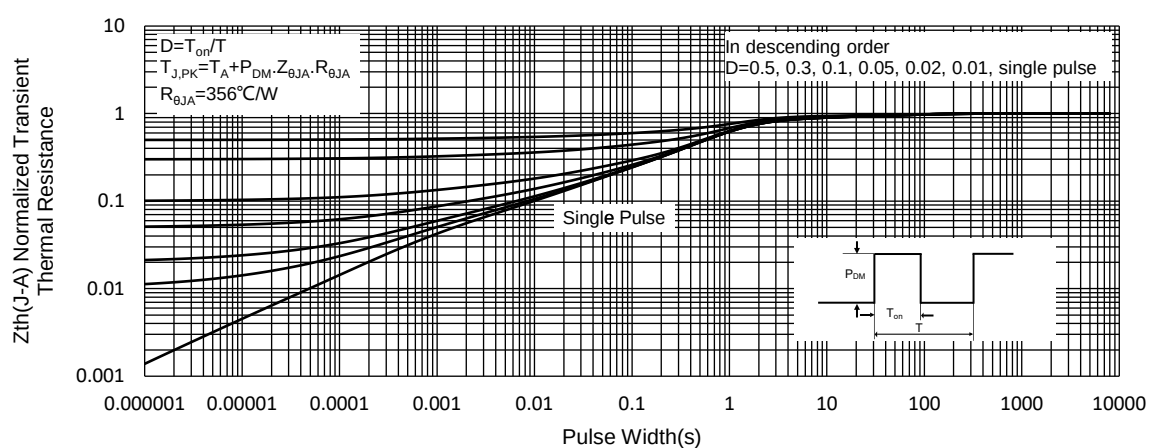


Fig.13 - Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel:3Kpcs/Reel

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